

INN700DC140A

1. General description

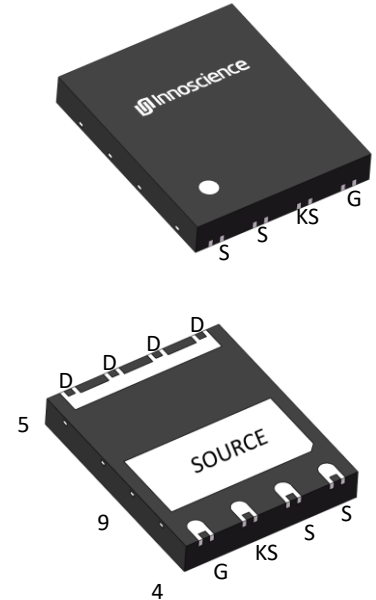
700V GaN-on-Silicon Enhancement-mode Power Transistor in Dual Flat No-lead package (DFN) with 5 mm × 6 mm size

2. Features

- Enhancement mode transistor-Normally off power switch
- Ultra high switching frequency
- No reverse-recovery charge
- Low gate charge, low output charge
- Qualified for industrial applications according to JEDEC Standards
- ESD safeguard
- RoHS, Pb-free, REACH-compliant

3. Applications

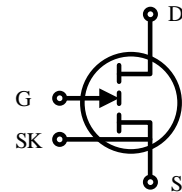
- AC-DC converters
- DC-DC converters
- Totem pole PFC
- Fast battery charging
- High density power conversion
- High efficiency power conversion



4. Key performance parameters

Table 1 Key performance parameters at $T_j = 25\text{ }^\circ\text{C}$

Parameter	Value	Unit
$V_{DS,max}$	700	V
$R_{DS(on),max}$ @ $V_{GS} = 6\text{ V}$	140	m Ω
$Q_{G,typ}$ @ $V_{DS} = 400\text{ V}$	3.5	nC
$I_{D,pulse}$	32	A
Q_{OSS} @ $V_{DS} = 400\text{ V}$	33	nC
Q_{rr} @ $V_{DS} = 400\text{ V}$	0	nC



5. Pin information

Table 2 Pin information

Gate	Drain	Kelvin Source	Source
4	5, 6, 7, 8	3	1, 2, 9

Table 3 Ordering information

Type/Ordering Code	Package	Product Code
INN700DC140A	DFN 5X6	70DC140A

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6. Maximum ratings

at $T_j = 25\text{ °C}$ unless otherwise specified.

Exceeding the maximum ratings may destroy the device. For further information, contact Innoscence sales office.

Table 4 Maximum ratings

Parameter	Symbol	Values	Unit	Note/Test Condition
Drain source voltage	$V_{DS, max}$	700	V	$V_{GS} = 0\text{ V}$, $T_j = -55\text{ °C to }150\text{ °C}$
Drain source voltage transient ¹	$V_{DS, transient}$	800	V	$V_{GS} = 0\text{ V}$
Drain source voltage, pulsed ²	$V_{DS, pulse}$	750	V	$T_j = 25\text{ °C}$; total time < 10 h
				$T_j = 125\text{ °C}$; total time < 1 h
Continuous current, drain source	I_D	17	A	$T_c = 25\text{ °C}$
Pulsed current, drain source ³	$I_{D, pulse}$	32	A	$T_c = 25\text{ °C}$; $V_{GS} = 6\text{ V}$; $t_{PULSE} = 300\text{ }\mu\text{s}$
Pulsed current, drain source ³	$I_{D, pulse}$	18	A	$T_c = 125\text{ °C}$; $V_{GS} = 6\text{ V}$; $t_{PULSE} = 300\text{ }\mu\text{s}$
Gate source voltage, continuous ⁴	V_{GS}	-1.4 to +7	V	$T_j = -55\text{ °C to }150\text{ °C}$
Gate source voltage, pulsed	$V_{GS, pulse}$	-20 to +10	V	$T_j = -55\text{ °C to }150\text{ °C}$; $t_{PULSE} = 50\text{ ns}$, $f = 100\text{ kHz}$; open drain
Power dissipation	P_{tot}	113	W	$T_c = 25\text{ °C}$
Operating temperature	T_j	-55 to +150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	

1. $V_{DS, transient}$ is intended for non-repetitive events, $t_{PULSE} < 200\text{ }\mu\text{s}$.

2. $V_{DS, pulse}$ is intended for repetitive pulse, $t_{PULSE} < 100\text{ ns}$.

3. Limit was extracted from characterization test, not measured during production.

4. The minimum V_{GS} is clamped by ESD protection circuit, as shown in Figure 10.

7. Thermal characteristics

Table 5 Thermal characteristics

Parameter	Symbol	Values	Unit	Note/Test Condition
Thermal resistance, junction-ambient	R_{thJA}	60.3	°C/W	
Thermal resistance, junction-case	R_{thJC}	1.1	°C/W	
Thermal resistance, junction-ambient	T_{sold}	260	°C	MSL3

8. Electric characteristics

 at $T_j = 25\text{ °C}$, unless specified otherwise

Table 6 Static characteristics

Parameter	Symbol	Values			Unit	Note/Test Condition
		Min.	Typ.	Max.		
Drain to Source Voltage	BVDSS	700	-	-	V	$V_{GS} = 0\text{ V}$, $I_{DS} = 40\mu\text{A}$
Gate threshold voltage	$V_{GS(th)}$	1.2	1.7	2.5	V	$I_D = 17.2\text{ mA}$; $V_{DS} = V_{GS}$; $T_j = 25\text{ °C}$
		-	1.7	-		$I_D = 17.2\text{ mA}$; $V_{DS} = V_{GS}$; $T_j = 150\text{ °C}$
Drain-source leakage current	I_{DSS}	-	0.6	25	μA	$V_{DS} = 700\text{ V}$; $V_{GS} = 0\text{ V}$; $T_j = 25\text{ °C}$
		-	7	-		$V_{DS} = 700\text{ V}$; $V_{GS} = 0\text{ V}$; $T_j = 150\text{ °C}$
Gate-source leakage current	I_{GSS}	-	70	900	μA	$V_{GS} = 6\text{ V}$; $V_{DS} = 0\text{ V}$
Drain-source on-state resistance	$R_{DS(on)}$	-	106	140	$\text{m}\Omega$	$V_{GS} = 6\text{ V}$; $I_D = 5\text{ A}$; $T_j = 25\text{ °C}$
		-	230	-	$\text{m}\Omega$	$V_{GS} = 6\text{ V}$; $I_D = 5\text{ A}$; $T_j = 150\text{ °C}$
Gate resistance	R_G	-	3.5	-	Ω	$f = 5\text{ MHz}$; open drain

Table 7 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note/Test Condition
		Min.	Typ.	Max.		
Input capacitance	C_{iss}	-	125	-	pF	$V_{GS} = 0\text{ V}$; $V_{DS} = 400\text{ V}$; $f = 100\text{ kHz}$
Output capacitance	C_{oss}	-	41	-	pF	$V_{GS} = 0\text{ V}$; $V_{DS} = 400\text{ V}$; $f = 100\text{ kHz}$
Reverse transfer Capacitance	C_{riss}	-	0.4	-	pF	$V_{GS} = 0\text{ V}$; $V_{DS} = 400\text{ V}$; $f = 100\text{ kHz}$
Effective output capacitance, energy related ¹	$C_{o(er)}$	-	59	-	pF	$V_{GS} = 0\text{ V}$; $V_{DS} = 0\text{ to }400\text{ V}$
Effective output capacitance, time related ²	$C_{o(tr)}$	-	82	-	pF	$V_{GS} = 0\text{ V}$; $V_{DS} = 0\text{ to }400\text{ V}$
Output charge	Q_{oss}	-	33	-	nC	$V_{GS} = 0\text{ V}$; $V_{DS} = 0\text{ to }400\text{ V}$
Turn-on delay time	$t_{d(on)}$	-	3	-	ns	$V_{DS} = 400\text{ V}$; $I_D = 10\text{ A}$; $L = 318\text{ }\mu\text{H}$; $V_{GS} = 6\text{ V}$; $R_{on} = 10\text{ }\Omega$; $R_{off} = 2\text{ }\Omega$; See Figure 22
Turn-off delay time	$t_{d(off)}$	-	4	-	ns	
Rise time	t_r	-	5	-	ns	
Fall time	t_f	-	4	-	ns	

 1. $C_{o(er)}$ is the fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400 V.

 2. $C_{o(tr)}$ is the fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400 V.

Table 8 Gate charge characteristics

Parameter	Symbol	Values			Unit	Note/Test Condition
		Min.	Typ.	Max.		
Gate charge	Q_G	-	3.5	-	nC	$V_{GS} = 0$ to 6 V; $V_{DS} = 400$ V; $I_D = 5$ A
Gate-source charge	Q_{GS}	-	0.3	-	nC	
Gate-drain charge	Q_{GD}	-	1.2	-	nC	
Gate Plateau Voltage	V_{Plat}	-	2.1	-	V	$V_{DS} = 400$ V; $I_D = 5$ A

Table 9 Reverse conduction characteristics

Parameter	Symbol	Values			Unit	Note/Test Condition
		Min.	Typ.	Max.		
Source-Drain reverse voltage	V_{SD}	-	2.4	-	V	$V_{GS} = 0$ V; $I_S = 5$ A
Pulsed current, reverse	$I_{S, pulse}$	-	-	32	A	$V_{GS} = 6$ V; $t_{PULSE} = 300$ μ s
Reverse recovery charge	Q_{rr}	-	0	-	nC	$I_S = 5$ A; $V_{DS} = 400$ V
Reverse recovery time	t_{rr}	-	0	-	ns	
Peak reverse recovery current	I_{rrm}	-	0	-	A	

9. Electric characteristics diagrams

at $T_j = 25\text{ }^\circ\text{C}$, unless specified otherwise

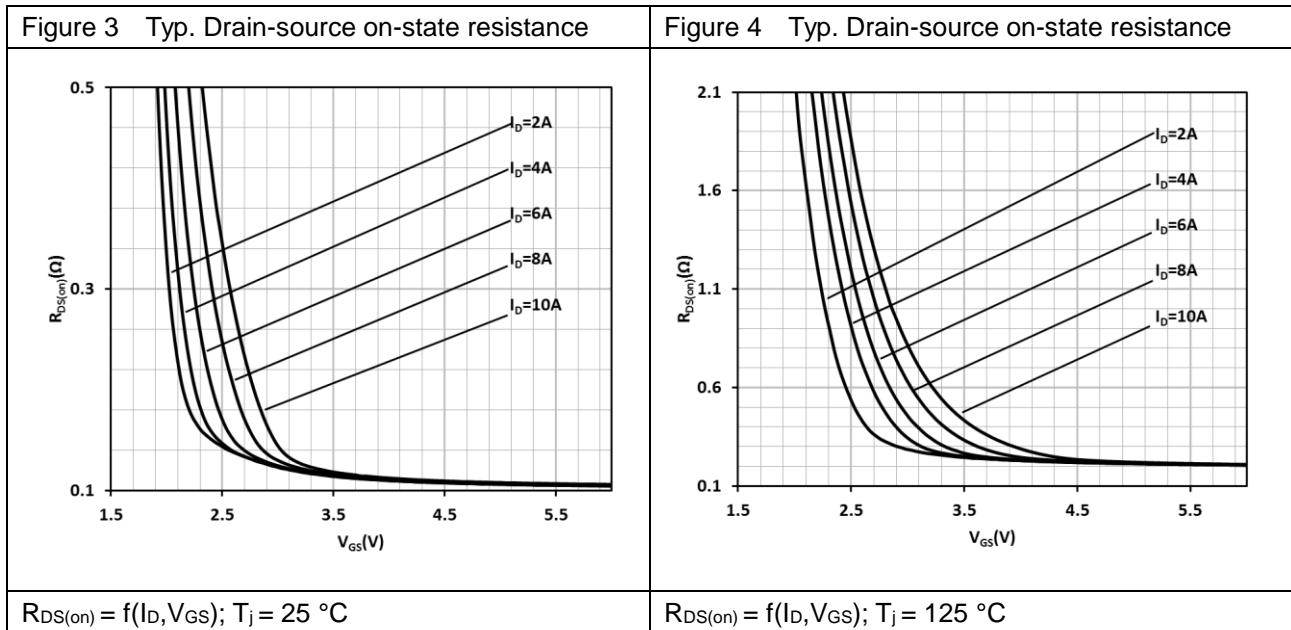
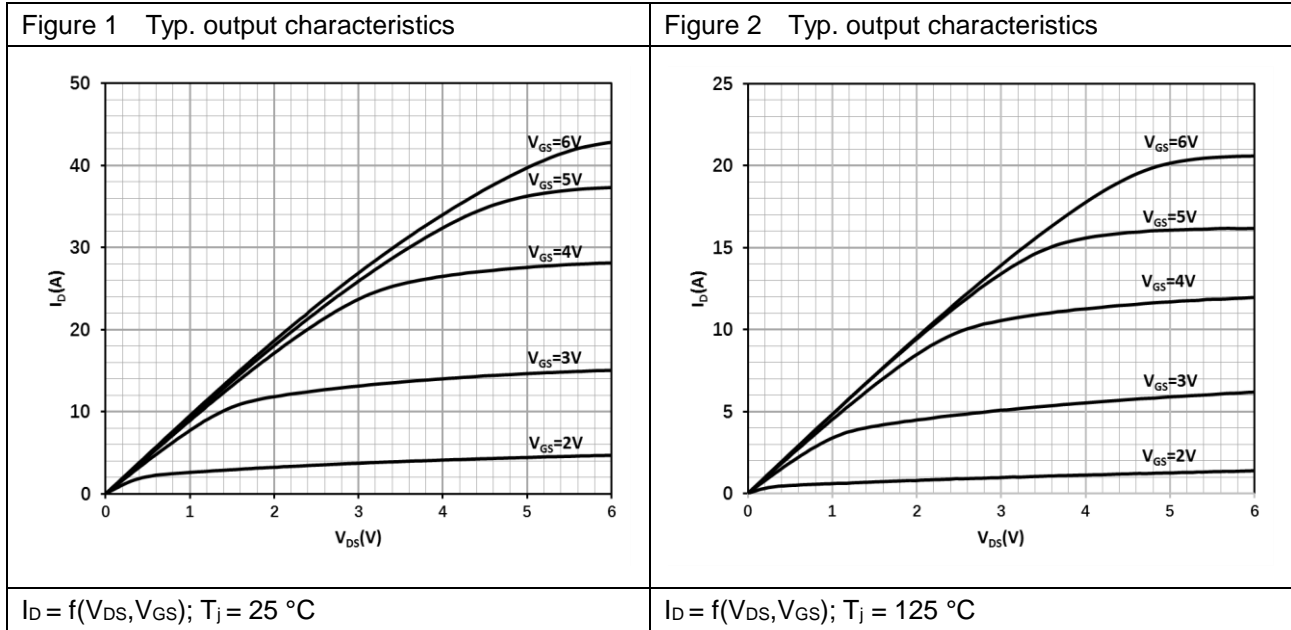
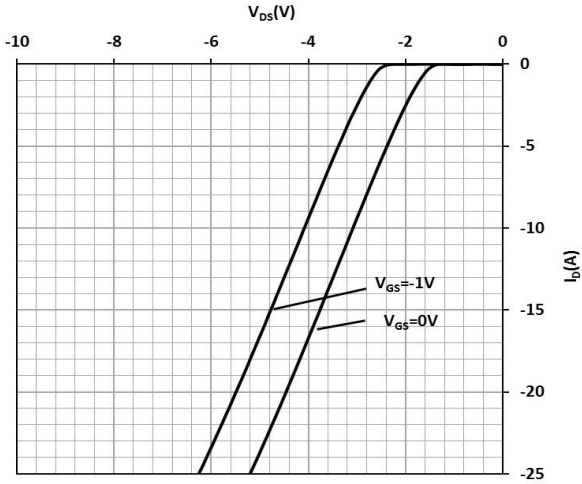
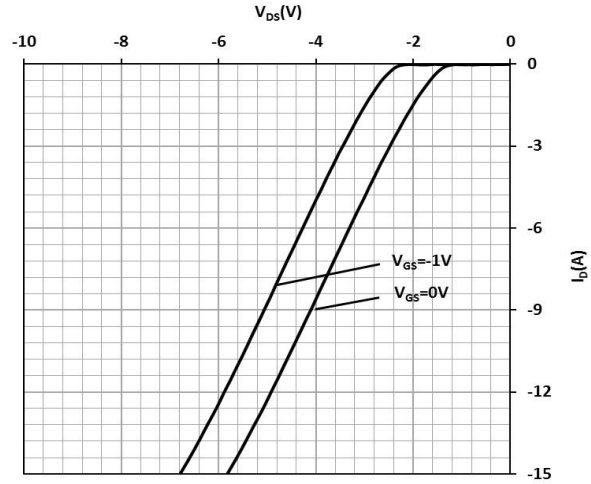


Figure 5 Typ. channel reverse characteristics



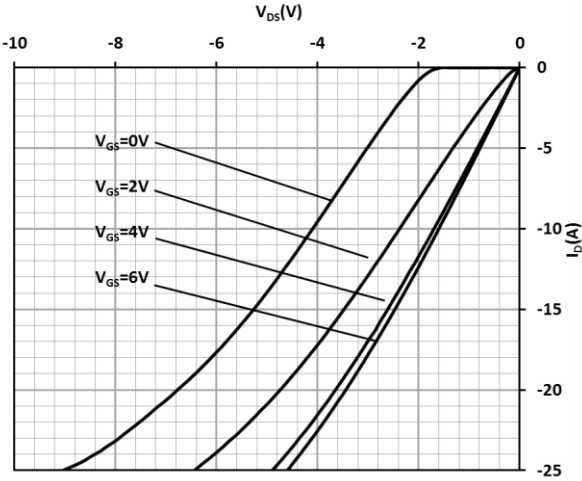
$I_D = f(V_{DS}, V_{GS}); T_j = 25\text{ °C}$

Figure 6 Typ. channel reverse characteristics



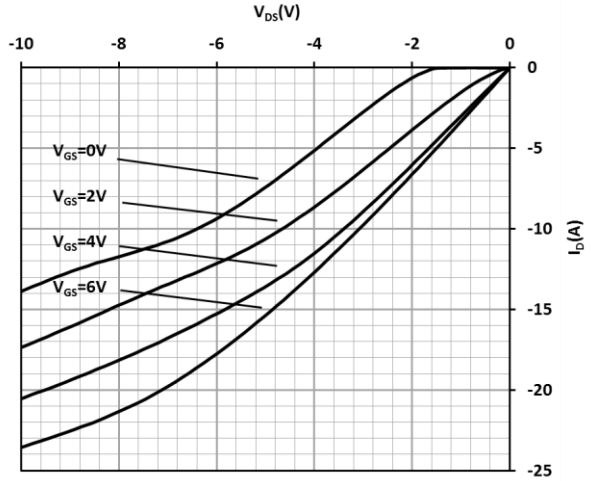
$I_D = f(V_{DS}, V_{GS}); T_j = 125\text{ °C}$

Figure 7 Typ. channel reverse characteristics



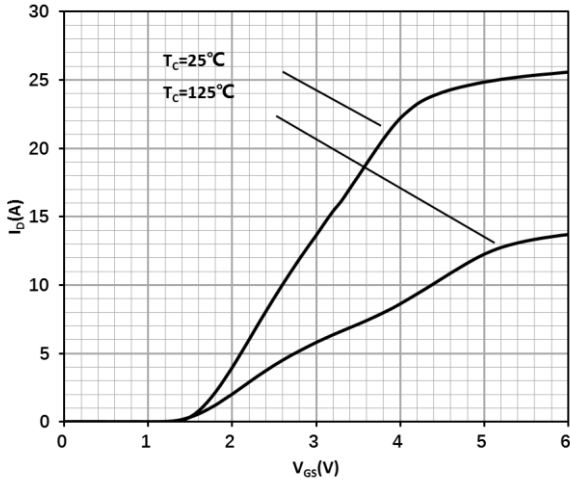
$I_D = f(V_{DS}, V_{GS}); T_j = 25\text{ °C}$

Figure 8 Typ. channel reverse characteristics



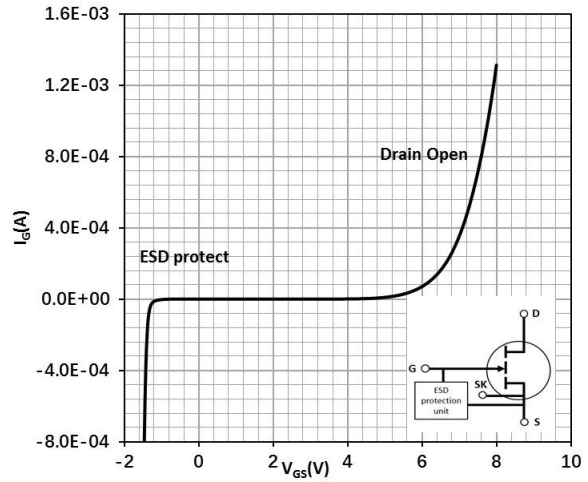
$I_D = f(V_{DS}, V_{GS}); T_j = 125\text{ °C}$

Figure 9 Typ. transfer characteristics



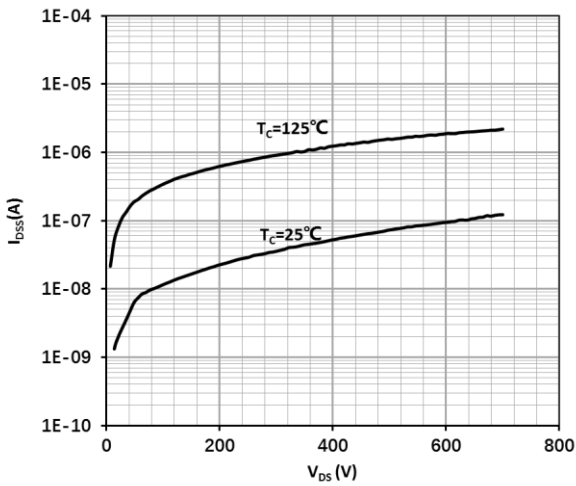
$I_D = f(V_{GS}); V_{DS} = 3\text{ V}$

Figure 10 Typ. Gate-to-Source leakage



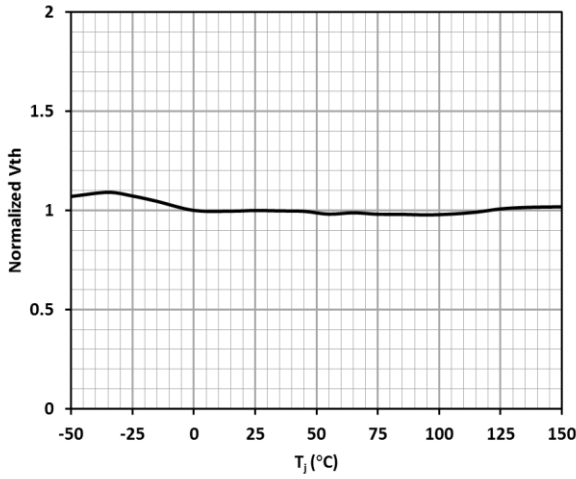
$I_G = f(V_{GS}); I_G$ reverse turn on by ESD unit

Figure 11 Drain-source leakage characteristics



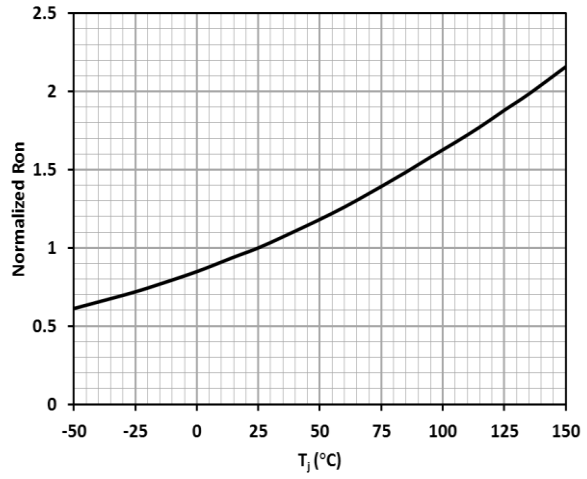
$I_{DSS} = f(V_{DS}); V_{GS} = 0\text{ V}$

Figure 12 Gate threshold voltage



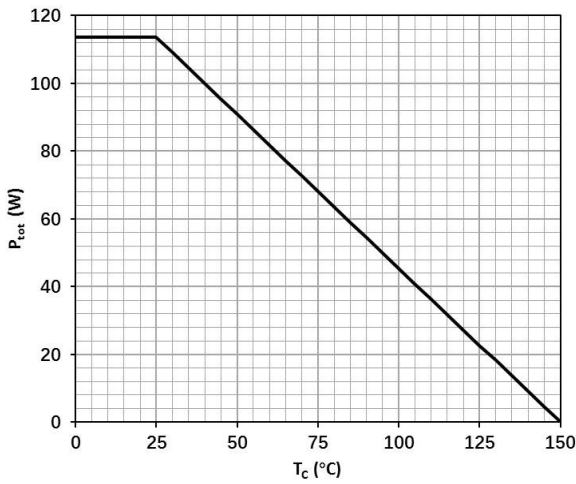
$V_{TH} = f(T_j)$; $V_{GS} = V_{DS}$; $I_D = 17.2 \text{ mA}$

Figure 13 Drain-source on-state resistance



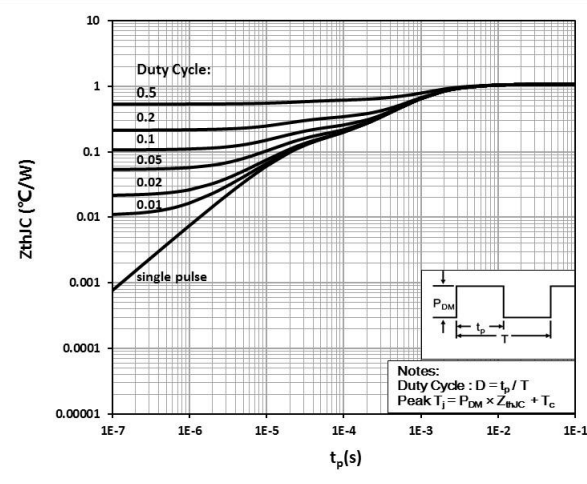
$R_{DS(on)} = f(T_j)$; $I_D = 5 \text{ A}$; $V_{GS} = 6 \text{ V}$

Figure 14 Power dissipation



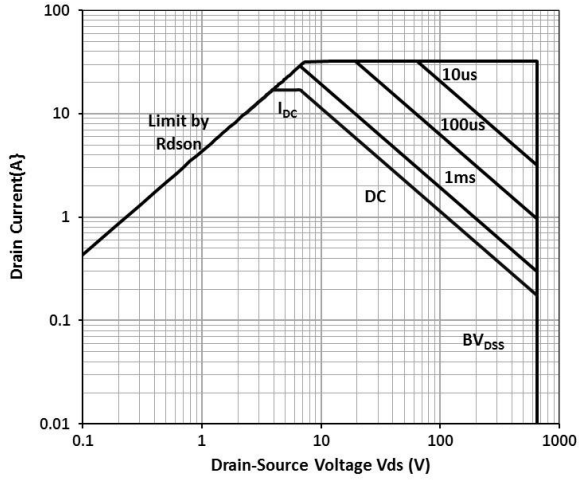
$P_{tot} = f(T_c)$

Figure 15 Max.transient thermal impedance



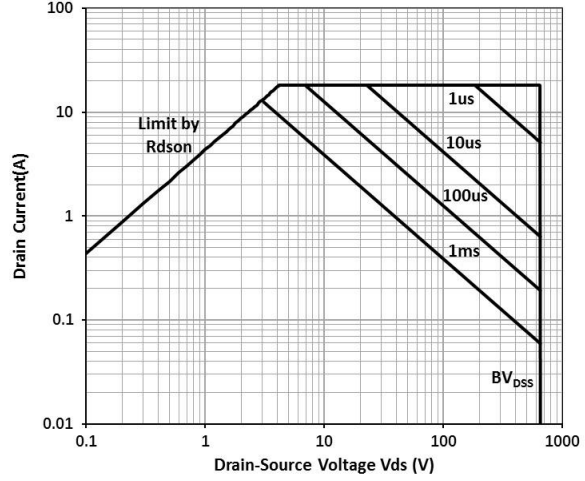
$Z_{thJC} = f(t_p, D)$

Figure 16 Safe operating area



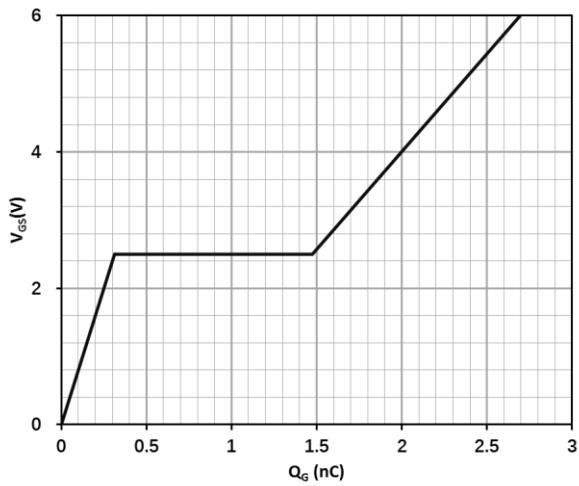
$I_D = f(V_{DS}); T_C = 25\text{ }^\circ\text{C}$

Figure 17 Safe operating area



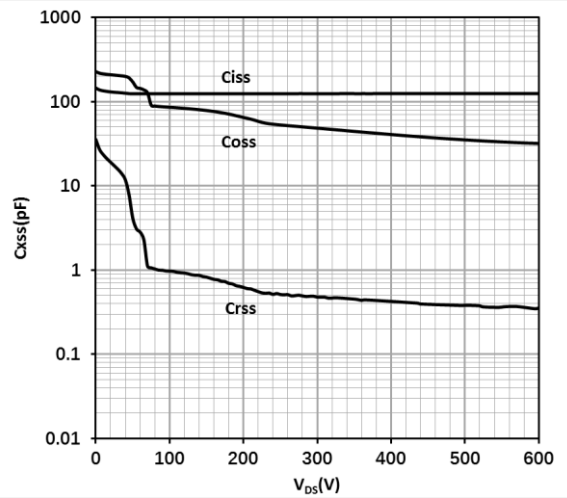
$I_D = f(V_{DS}); T_C = 125\text{ }^\circ\text{C}$

Figure 18 Typ. gate charge



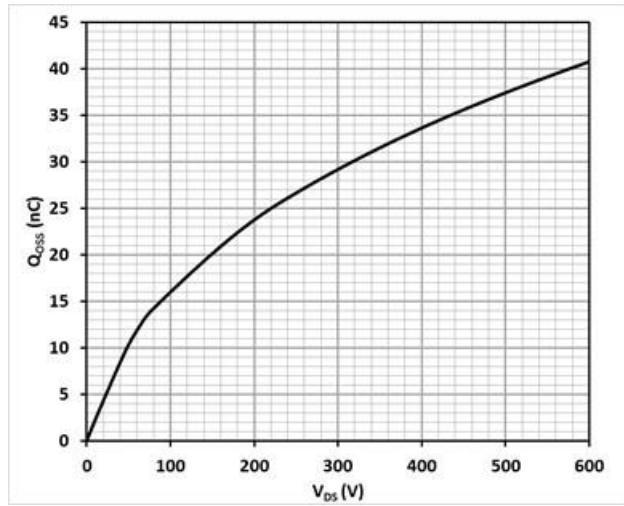
$V_{GS} = f(Q_G); V_{DCLINK} = 400\text{ V}; I_D = 5\text{ A}$

Figure 19 Typ. capacitances



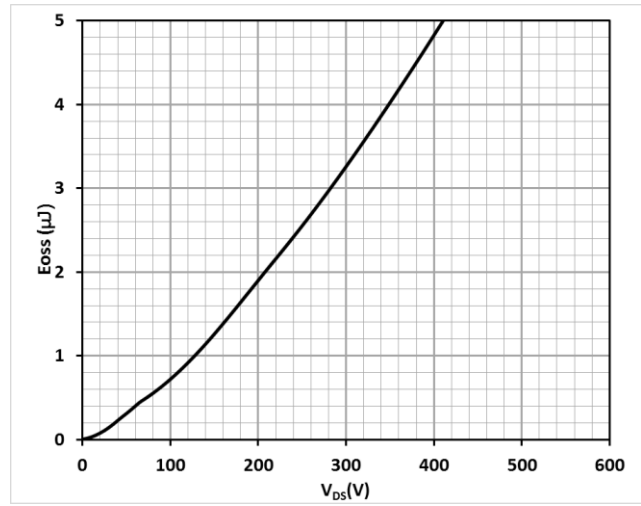
$C_{XSS} = f(V_{DS}); \text{Freq.} = 100\text{ kHz}$

Figure 20 Typ. output charge



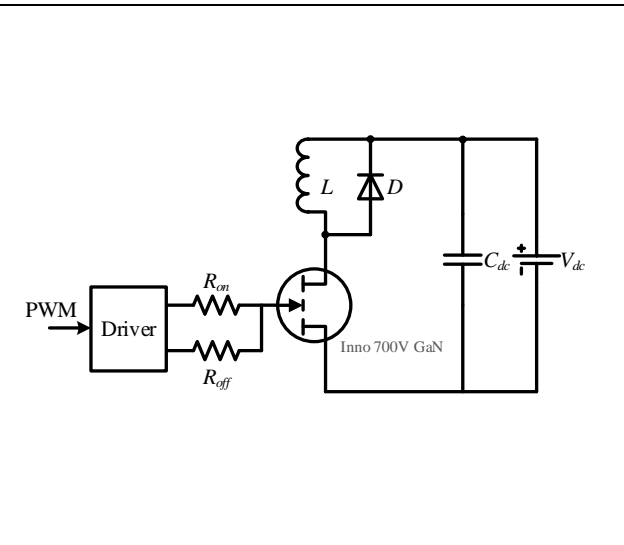
$Q_{oss} = f(V_{DS}); \text{Freq.} = 100 \text{ kHz}$

Figure 21 Typ. Coss stored Energy



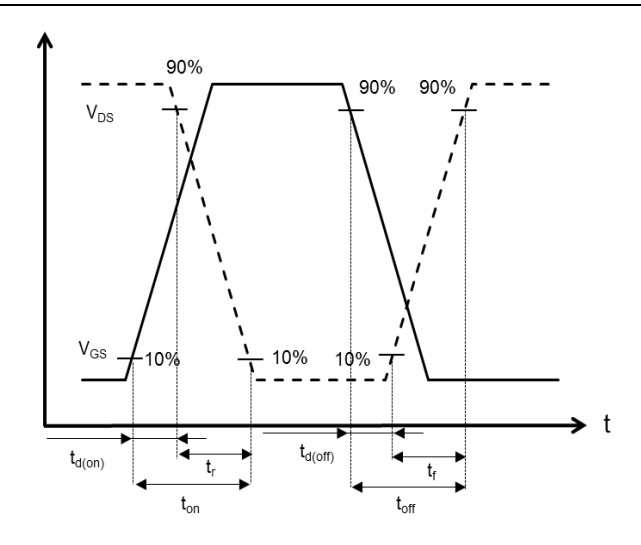
$E_{oss} = f(V_{DS}); \text{Freq.} = 100 \text{ kHz}$

Figure 22 Typ. Switching times with inductive load

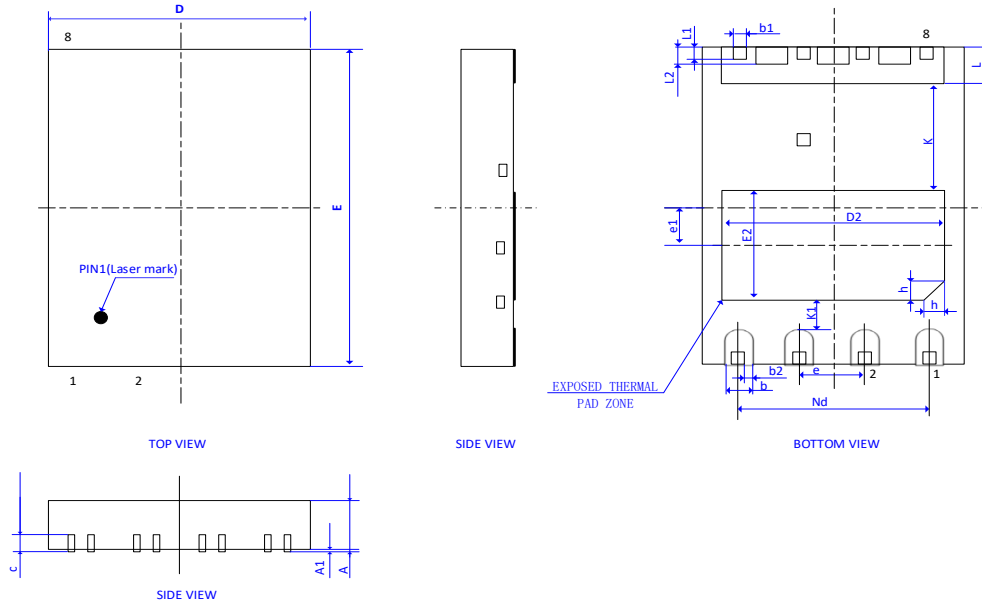


$V_{DS} = 400 \text{ V}, I_D = 10 \text{ A}, L = 318 \mu\text{H}, V_{GS} = 6 \text{ V},$
 $R_{on} = 10 \Omega, R_{off} = 2 \Omega$

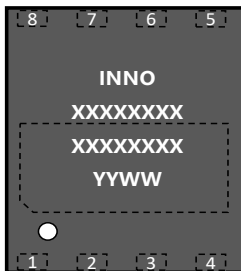
Figure 23 Typ. Switching times waveform



10. Package outlines



SYMBOL	MILLIMETER			SYMBOL	MILLIMETER		
	MIN	NOM	MAX		MIN	NOM	MAX
A	0.80	0.85	0.90	N_d		3.81BSC	
A1	0.00	0.02	0.05	E	5.90	6.00	6.10
b	0.40	0.45	0.50	E2	1.95	2.05	2.15
b1	0.20REF			L	0.625	0.675	0.725
b2	0.125REF			L1	0.15REF		
c	0.203REF			L2	0.25REF		
D	4.90	5.00	5.10	h	0.30	0.35	0.40
D2	4.16	4.26	4.36	K	2.1REF		
e	1.27BSC			K1	0.50REF		
e1	0.80BSC						

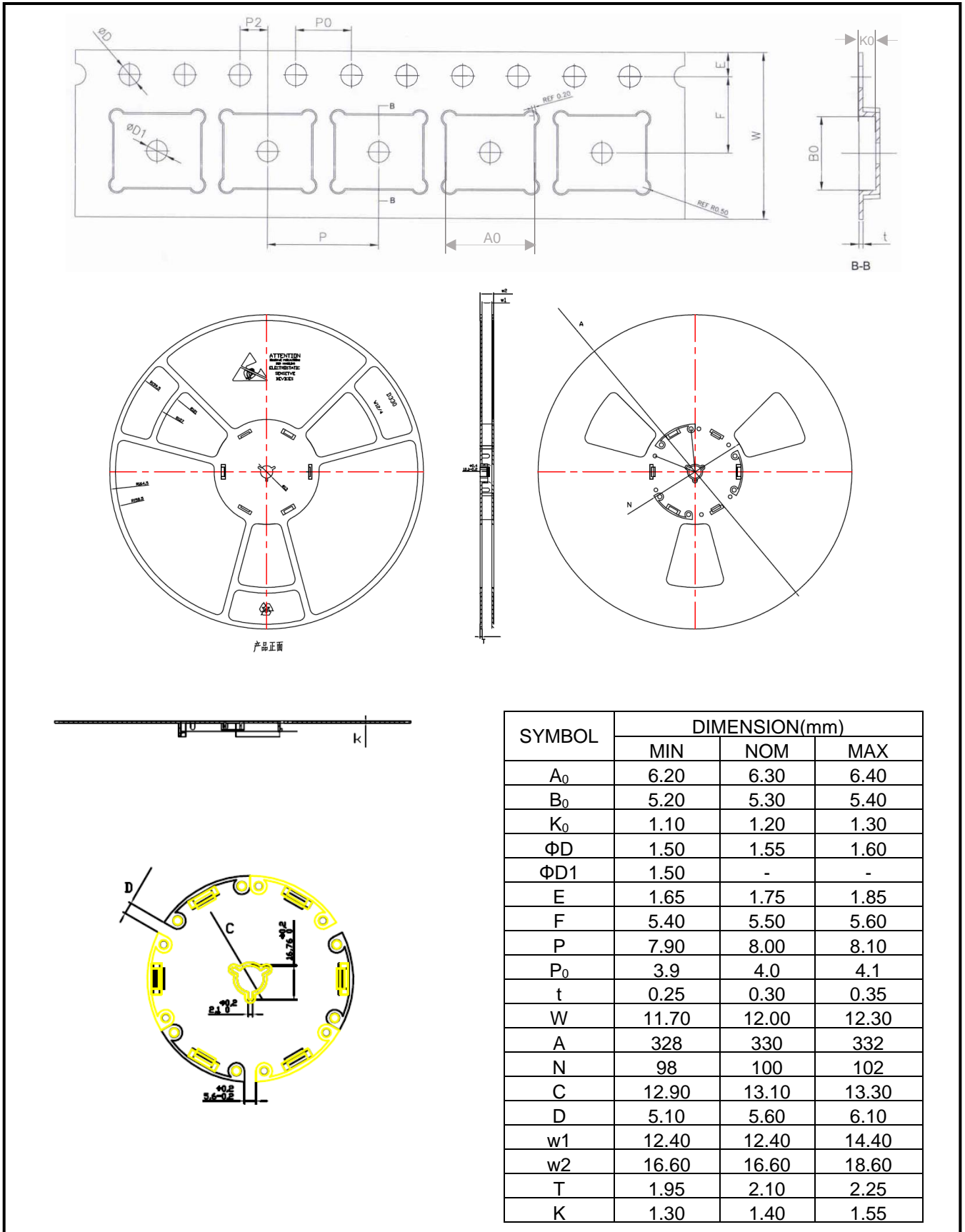


Row	Description	Example
Row1	Company name	INNO
Row2	Product code (In short)	XXXXXXXX
Row3	ASSY lot No.	XXXXXXXX
Row4	Date code	YYWW

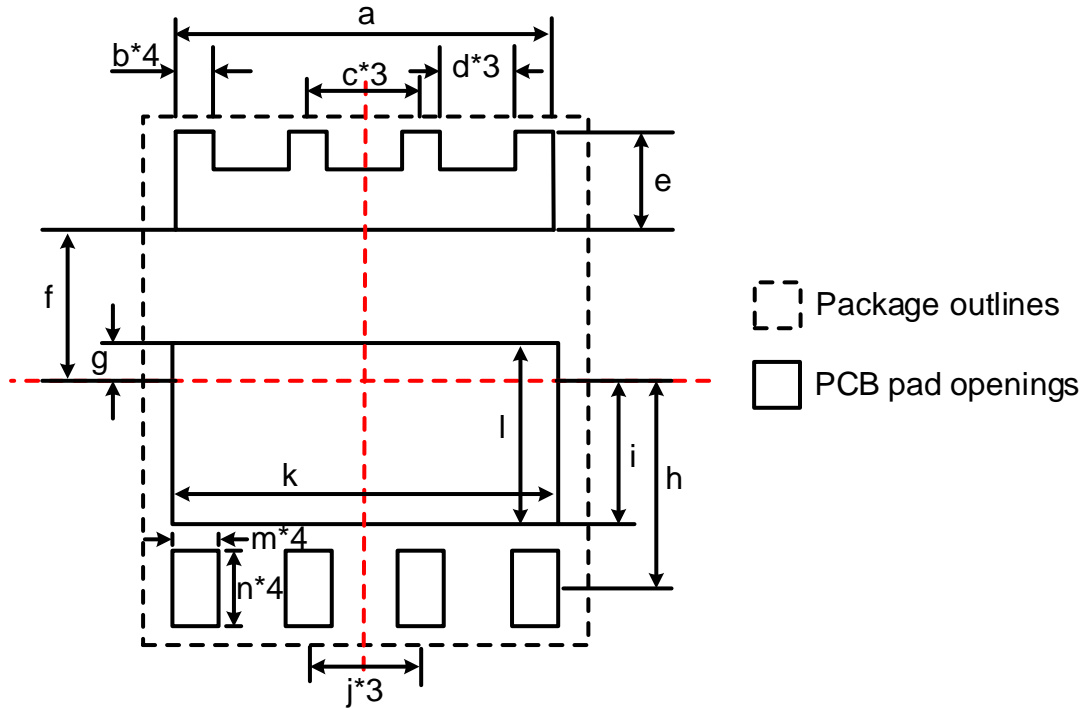
Notes:

- (1) Dimension and tolerance conform to ASME Y14.5-2009.
- (2) All dimension are in millimeters.
- (3) Lead coplanarity shall be 0.1 millimeters max.
- (4) Complies with JEDEC MO-229.
- (5) Drawing is not to scale.
- (6) Dimensions do not include mold protrusion.
- (7) Package outline exclusive of metal burr dimensions.

11. Reel information



12. Recommended PCB footprint



SYMBOL	DIMENSION	SYMBOL	DIMENSION
a	4.340	h	2.900
b	0.530	i	1.875
c	1.270	j	1.270
d	0.740	k	4.360
e	1.190	l	2.150
f	2.315	m	0.550
g	0.275	n	1.000

Notes:

- (1) All dimension are in millimeters.
- (2) Drawing is not to scale.

13. Revision history

Major changes since the last revision

Revision	Date	Description of changes
1.0	2022-08-20	1.0 version release
1.1	2022-10-17	<ol style="list-style-type: none">1. Add BV_{DSS} minimum value2. Add I_{ESS} maximum value3. Update tape and reel information

Important Notice

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